TOSHIBA Photocoupler Photorelay

# TLP4197G

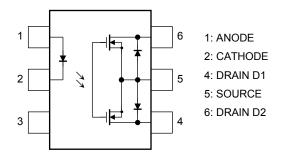
PBX Telecommunication Modem · FAX Cards, Modems In PC Measurement Instrumentation

The TOSHIBA TLP4197G consists of an infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface mount assembly.

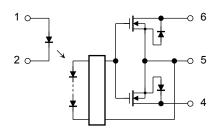
The TLP4197GA is suitable for replacement of mechanical relays in many applications which require space savings.

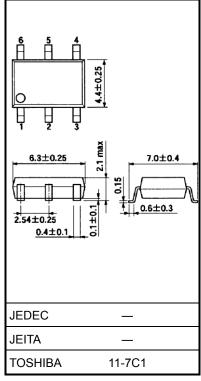
- 6 pin SOP (2.54SOP6): 2.1 mm high, 2.54 mm pitch
- 1-form-B
- Peak off-state voltage: 350 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- On-state resistance: 25 Ω (max)
- Isolation voltage: 1500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349

#### Pin Configuration (top view)



#### Schematic





Weight: 0.13 g (typ.)

Unit: mm

#### Absolute Maximum Ratings (Ta = 25°C)

<b>3</b> ( )								
Characteristics			Symbol	Rating	Unit			
	Forward current		lF	50	mA			
	Forward current (Ta ≥ 25°C)	derating	∆lF/°C	-0.5	mA/°C			
	Peak forward cu (100 µs pulse, 1		IFP	1	А			
LED	Reverse voltage		VR	5	V			
	Diode power dis	sipation	PD	50	mW			
	Diode power dissipation derating (Ta $\ge$ 25°C)		ΔP <sub>D</sub> /°C	-0.5	mW/°C			
	Junction temper	ature	Tj	125	°C			
	Off-state output	terminal voltage	Voff	350	V			
		A connection		120				
	On-state current	B connection	ION	120	mA			
		C connection		240				
	On-state current	A connection		-1.2				
	derating	B connection	∆l <sub>ON</sub> /°C	-1.2	mA/°C			
ctor	(Ta ≥ 25°C)	C connection		-2.4				
Detector		A connection		360				
	Output power dissipation	B connection	Po	201	mW			
		C connection		403				
	Output power			-3.6				
	dissipation derating	B connection	ΔPo /°C	-2.0	mW /°C			
	(Ta ≥ 25°C)	C connection		-4.0				
	Junction temper	ature	Tj	125	°C			
Oper	rating temperature	e range	T <sub>opr</sub>	-40 to 85	°C			
Stora	age temperature i	ange	T <sub>stg</sub>	-55 to 125	°C			
Lead	I soldering tempe	rature (10 s)	T <sub>sol</sub>	260	°C			
	tion voltage 60 s, R.H. ≤ 60 %	%) (Note 1)	BVS	1500	Vrms			

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: LED side pins shorted together, and DETECTOR side pins and 6 shorted together.

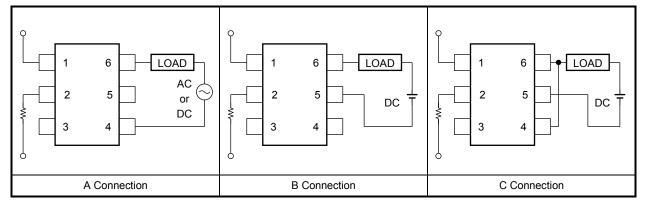
#### **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V <sub>DD</sub>	_	_	280	V
Forward current	lF	5	_	25	mA
On-state current	ION	-	_	120	mA
Operating temperature	T <sub>opr</sub>	-20	—	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

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#### **Circuit Connections**



**Electrical Characteristics (Ta = 25°C)** 

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μA
	Capacitance	CT	V <sub>F</sub> = 0 V, f = 1 MHz	_	30	_	pF
ctor	Off-state current	IOFF	V <sub>OFF</sub> = 350 V, I <sub>F</sub> = 5 mA	_	—	1	μA
Detector	Capacitance	COFF	V = 0 V, f = 1 MHz, IF = 5 mA		65		pF

## Coupled Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		IFC	loff = 10 μA	_	1	3	mA
Return LED current		IFT	I <sub>ON</sub> = 120 mA	0.1	_	_	mA
	A connection		I <sub>ON</sub> = 120 mA	_	15	25	
On-state resistance	B connection		I <sub>ON</sub> = 120 mA	_	8	14	Ω
	C connection		I <sub>ON</sub> = 240 mA	_	4		

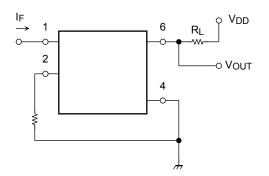
## Isolation Characteristics (Ta = 25°C)

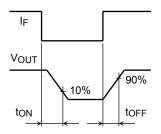
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V <sub>S</sub> = 0 V, f = 1 MHz	—	0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H.≦60 %	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVs	AC, 60 s	1500			Vrms

## Switching Characteristics (Ta = 25°C)

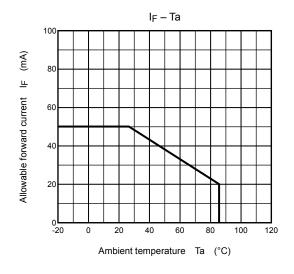
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	R <sub>L</sub> = 200 Ω (Note 2	) —	—	1	ms
Turn-off time	tOFF	V <sub>DD</sub> = 20 V, I <sub>F</sub> = 5 mA	_		3	ms

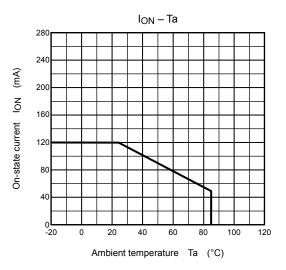
Note 2: Switching time test circuit

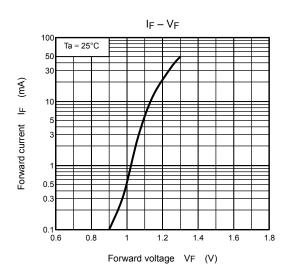


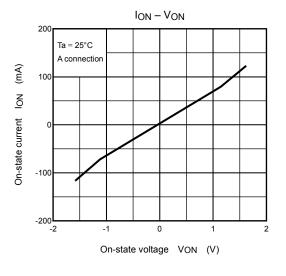


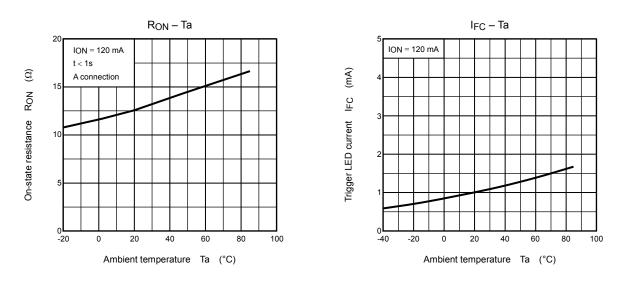
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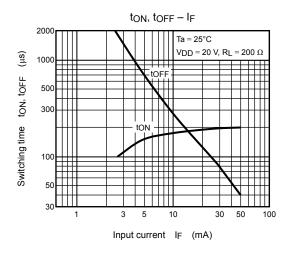


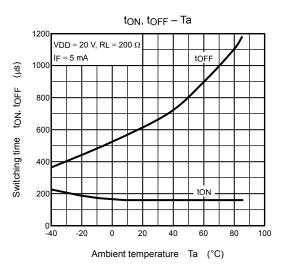


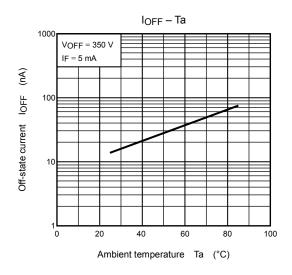




NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.







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